

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
WASHINGTON, D.C. 20231**

Inventor: **My Nguyen**

Serial No: **Div. of 10/047617**

Filed: **January 14, 2002**

For: **Thermal Interface Materials**

Examiner:

Art Unit:

**PRELIMINARY AMENDMENT**

Mail Stop Patent Application  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Please enter the following preliminary amendment:

**IN THE CLAIMS**

Please cancel all allowed claims (1-31) and add the following claims addressing subject matter in application serial number 10/047617:

32. A gel material comprising at least one thermally conductive filler, at least one rubber compound crosslinked to at least one amine resin.
33. The gel material of claim 32, wherein the material is a thermal interface material.
34. The gel material of claim 32, further comprising at least one phase change material.
35. The gel material of claim 32, wherein the at least one rubber compound is crosslinked to the at least one amine resin by at least one terminal hydroxy group on the rubber compound.